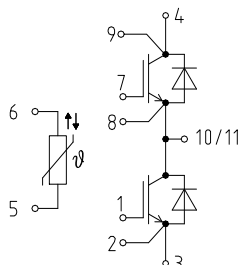
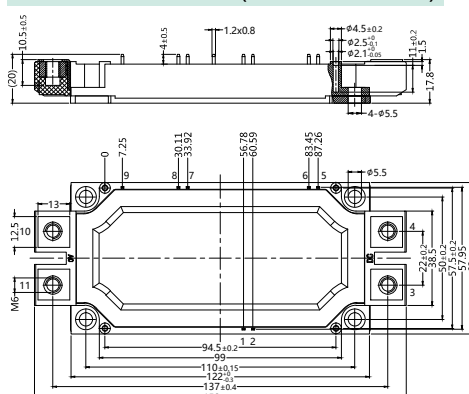


## IGBT Modules



Dimensions in mm (1mm = 0.0394")



$T_c = 25^{\circ}\text{C}$ , unless otherwise specified

| Symbol        | Conditions                                                       | Values     | Units              |
|---------------|------------------------------------------------------------------|------------|--------------------|
| IGBT          |                                                                  |            |                    |
| $V_{CES}$     |                                                                  | 1700       | V                  |
| $I_C$         | $T_C = 100^{\circ}\text{C}$                                      | 450        | A                  |
| $I_{CRM}$     | $T_C = 25^{\circ}\text{C}$ , $t_P = 1\text{ms}$                  | 900        | A                  |
| $V_{GES}$     |                                                                  | $\pm 20$   | V                  |
| $T_{Vj}$      |                                                                  | -40...+175 | $^{\circ}\text{C}$ |
| Inverse Diode |                                                                  |            |                    |
| $I_F = -I_C$  | $T_C = 100^{\circ}\text{C}$                                      | 450        | A                  |
| $I_{FRM}$     | $T_C = 25^{\circ}\text{C}$ , $t_P = 1\text{ms}$                  | 900        | A                  |
| $I_{FSM}$     | $t_P = 10\text{ms}$ ; sin.; $T_j = 150^{\circ}\text{C}$          | 1480       | A                  |
| Module        |                                                                  |            |                    |
| $I_{t(RMS)}$  | $T_{terminal} = 100^{\circ}\text{C}$                             | 600        | A                  |
| $T_{stg}$     |                                                                  | -40~125    | $^{\circ}\text{C}$ |
| $V_{isol}$    | AC, 1min                                                         | 4000       | V                  |
| $P_{tot}$     | $T_C = 25^{\circ}\text{C}$ , $T_{Vj\ max} = 175^{\circ}\text{C}$ | 2500       | W                  |

## Features

- Trench Field Stop IGBT technology
- Low Switching losses
- Switching frequency upto 20KHz
- Square RBSOA, no latch up
- High short circuit capability Positive temperature coefficient for easy parallelling
- MOS input, voltage controlled
- Ultra fast free wheeling diodes
- Package with copper baseplate
- Isolation voltage 4000 V

## Application

- AC and DC motor control
- AC servo and robot drives
- Power supplies
- Welding inverters

## Advantages

- Space and weight savings
- Reduced protection circuits

# SGG450T170UC5

## IGBT Modules

### Characteristics

$T_c = 25^{\circ}\text{C}$ , unless otherwise specified

| Symbol                                    | Conditions                                                                  | min. | typ.          | max.       | Units         |
|-------------------------------------------|-----------------------------------------------------------------------------|------|---------------|------------|---------------|
| IGBT                                      |                                                                             |      |               |            |               |
| $V_{GE(th)}$                              | $V_{GE} = V_{CE}$ , $I_C = 8\text{mA}$                                      | 5.0  | 5.8           | 6.5        | V             |
| $I_{CES}$                                 | $V_{GE} = 0$ ; $V_{CE} = V_{CES}$ ; $T_j = 25^{\circ}\text{C}$              |      |               | 4.0        | mA            |
| $V_{CE(TO)}$                              | $T_j = 25^{\circ}\text{C}$                                                  |      | 0.8           | 0.9        | V             |
| $r_{CE}$                                  | $V_{GE} = 15\text{V}$ , $T_j = 25(125)^{\circ}\text{C}$                     |      | 3.30(5.00)    | 3.80(5.30) | m $\Omega$    |
| $V_{CE(sat)}$                             | $I_C = 450\text{A}$ ; $V_{GE} = 15\text{V}$ ; chip level                    |      | 2.10          | 2.55       | V             |
| $C_{ies}$                                 | under following conditions                                                  |      | 44.00         |            | nF            |
| $C_{oes}$                                 | $V_{GE} = 0$ , $V_{CE} = 25\text{V}$ , $f = 1\text{MHz}$                    |      | 1.29          |            |               |
| $C_{res}$                                 |                                                                             |      | 1.08          |            |               |
| $L_{CE}$                                  |                                                                             |      |               | 20         | nH            |
| $R_{CC'+EE'}$                             | res., terminal-chip $T_c = 25(125)^{\circ}\text{C}$                         |      | 1.2(1.65)     |            | m $\Omega$    |
| $t_{d(on)}$                               | under following conditions:<br>$V_{CC} = 900\text{V}$ , $I_C = 450\text{A}$ |      | 250           |            | ns            |
| $t_r$                                     | $R_{Gon} = R_{Goff} = 3\Omega$ , $T_j = 125^{\circ}\text{C}$                |      | 108           |            | ns            |
| $t_{d(off)}$                              | $V_{GE} = \pm 15\text{V}$                                                   |      | 610           |            | ns            |
| $t_f$                                     |                                                                             |      | 510           |            | ns            |
| $E_{on}(E_{off})$                         |                                                                             |      | 133(118)      |            | mJ            |
| Inverse Diode under following conditions: |                                                                             |      |               |            |               |
| $V_F = V_{EC}$                            | $I_F = 450\text{A}$ ; $V_{GE} = 0\text{V}$ ; $T_j = 25^{\circ}\text{C}$     |      | 2.40          | 2.92       | V             |
| $V_{(FO)}$                                | $T_j = 25^{\circ}\text{C}$                                                  |      | 1.40          | 1.60       | V             |
| $r_F$                                     | $T_j = 25^{\circ}\text{C}$                                                  |      | 3.6           | 3.9        | m $\Omega$    |
| $I_{RRM}$                                 | $I_F = 450\text{A}$ ; $T_j = 125^{\circ}\text{C}$                           |      | 230           |            | A             |
| $Q_{rr}$                                  | $di/dt = 3300\text{A/us}$                                                   |      | 80            |            | $\mu\text{C}$ |
| $E_{rr}$                                  | $V_{GE} = \pm 15\text{V}$                                                   |      | 43            |            | mJ            |
| Thermal Characteristics                   |                                                                             |      |               |            |               |
| $R_{th(j-c)}$                             | per IGBT                                                                    |      |               | 0.094      | K/W           |
| $R_{th(j-c)D}$                            | per Inverse Diode                                                           |      |               | 0.150      | K/W           |
| $R_{th(c-s)}$                             | per module                                                                  |      |               | 0.011      | K/W           |
| Mechanical Data                           |                                                                             |      |               |            |               |
| $M_s$                                     | to heatsink M5                                                              | 3    |               | 6          | Nm            |
| $M_t$                                     | to terminals M6                                                             | 3    |               | 6          | Nm            |
| Weight                                    | typical                                                                     |      |               | 350        | g             |
| Temperature Sensor                        |                                                                             |      |               |            |               |
| $R_{100}$                                 | $T_c = 100^{\circ}\text{C}$ ( $R_{25} = 5\text{ k}\Omega$ )                 |      | 493 $\pm$ 5%  |            | $\Omega$      |
| $B_{100/125}$                             | $R(T) = R_{100} \exp[B_{100/125}(1/T - 1/T_{100})]$ ; $T[\text{K}]$         |      | 3550 $\pm$ 2% |            | K             |

**Sirectifier®**

# SGG450T170UC5

## IGBT Modules

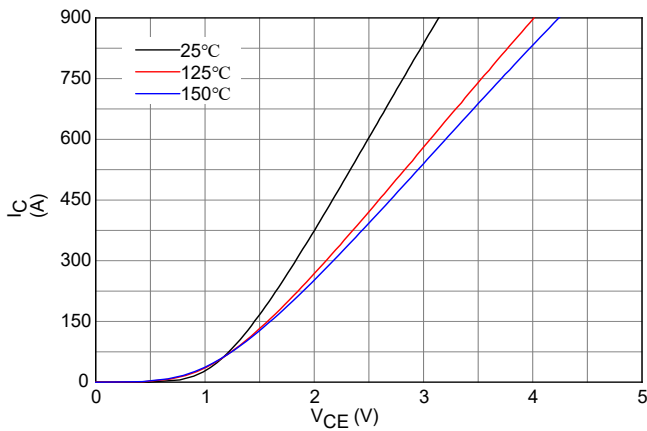


Figure 1. Typical output characteristics (VGE=15V)

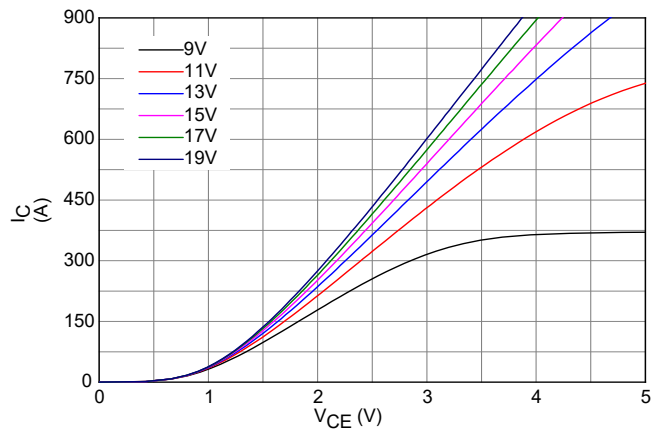


Figure 2. Typical output characteristics (TVj=150°C)

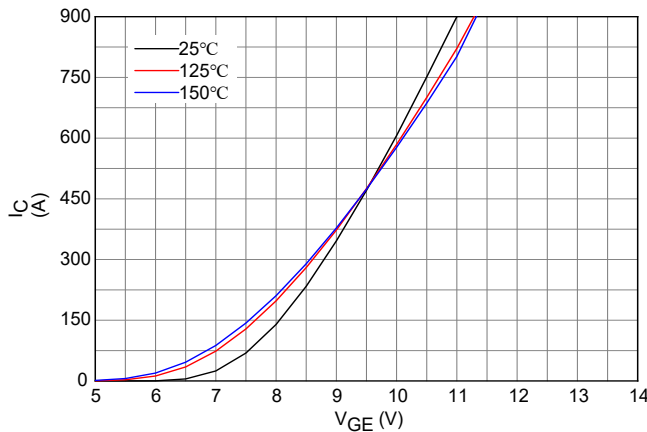


Figure 3. Typical transfer characteristic (VCE=20V)

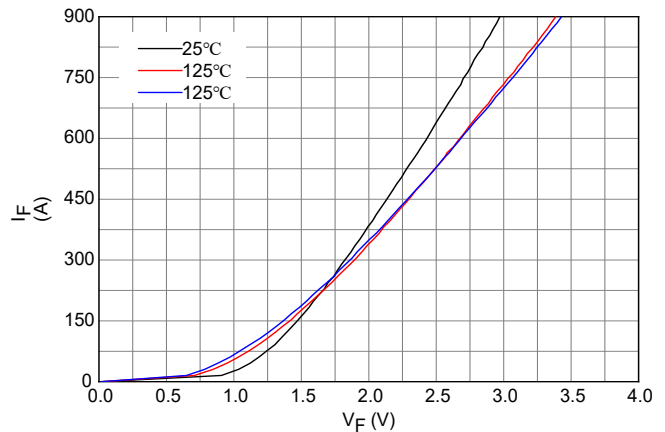


Figure 4. Forward characteristic of Diode

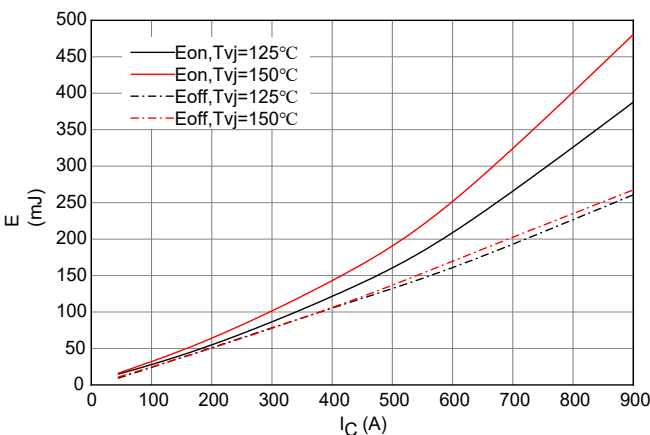


Figure 5. Switching losses of IGBT  
VGE=±15V, RGon=3.3Ω, RGoff=3.3Ω, VCE=900V

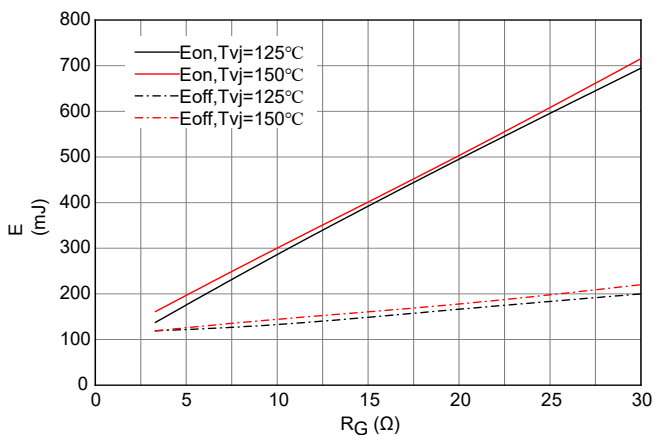


Figure 6. Switching losses of IGBT  
VGE=±15V, IC=450A, VCE=900V

# SGG450T170UC5

## IGBT Modules

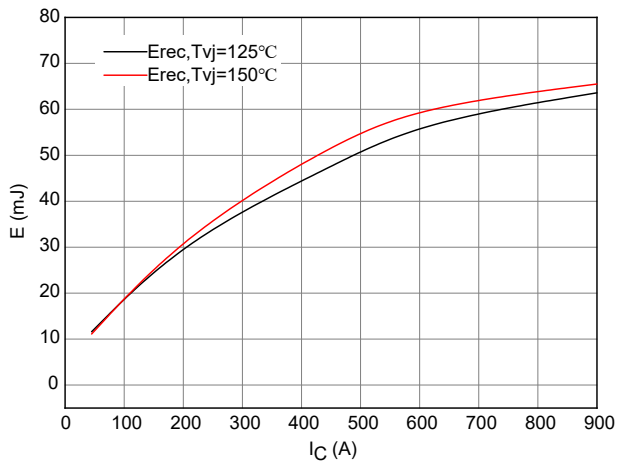


Figure 7. Switching losses of Diode  
 $R_{Gon}=3.3\Omega$ ,  $V_{CE}=900V$

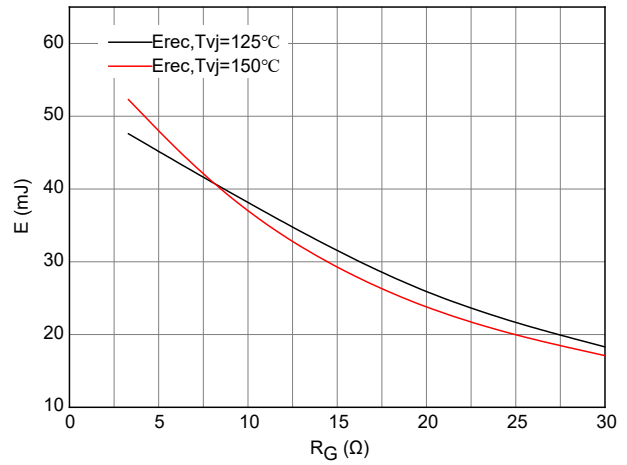


Figure 8. Switching losses of Diode  
 $I_F=450A$ ,  $V_{CE}=900V$

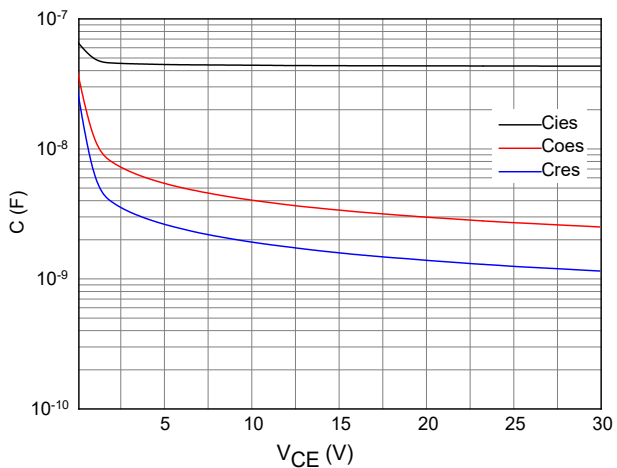


Figure 9. Capacitance characteristic

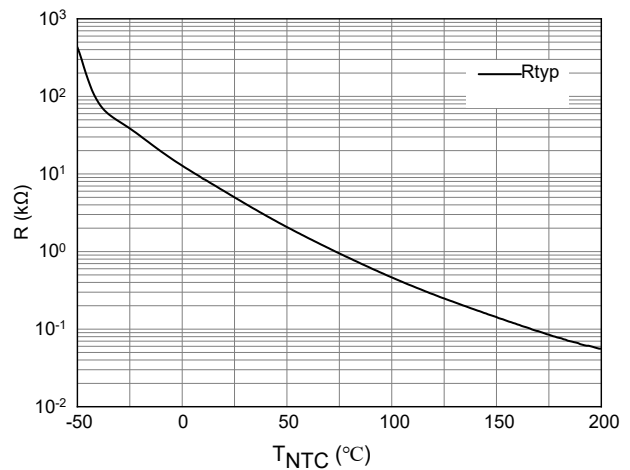


Figure 10. NTC-Themistor-temperature characteristic